74LVC139 Dual 2-to-4 line decoder/demultiplexer Rev. 5 – 19 October 2011

Product data sheet

1. General description

The 74LVC139 is a dual 2-to-4 line decoder/demultiplexer. It has two independent decoders, each accepting two binary weighted inputs (nA0 and nA1) and providing four mutually exclusive outputs ($n\overline{Y}0$ to $n\overline{Y}3$) that are LOW when selected. Each decoder has an active LOW input ($n\overline{E}$). When $n\overline{E}$ is HIGH, every output is forced HIGH. The enable input can be used as the data input for a 1-to-4 demultiplexer application.

2. Features and benefits

- Wide supply voltage range from 1.2 V to 3.6 V
- Inputs accept voltages up to 5.5 V
- CMOS low power consumption
- Direct interface with TTL levels
- Demultiplexing capability
- Two independent 2-to-4 decoders
- Multifunction capability
- Mutually exclusive outputs
- Output drive capability 50 Ω transmission lines at 125 °C
- Complies with JEDEC standard:
 - JESD8-7A (1.65 V to 1.95 V)
 - JESD8-5A (2.3 V to 2.7 V)
 - JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-B exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Specified from –40 °C to +85 °C and from –40 °C to +125 °C

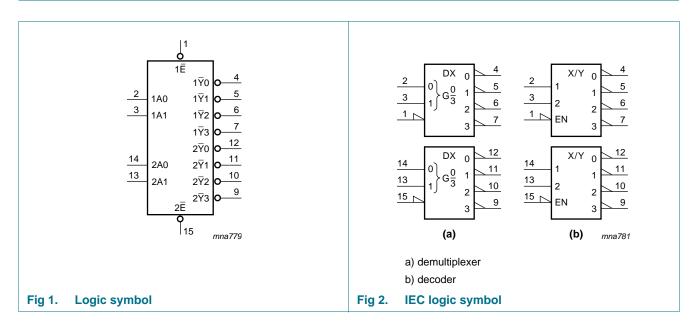


Dual 2-to-4 line decoder/demultiplexer

3. Ordering information

| Table 1. Orde | ering information | | | | | | | | |
|---------------|-------------------|----------|--------------------------------------------------------------------------------------------------------------------------------------------|----------|--|--|--|--|--|
| Type number | Package | ickage | | | | | | | |
| | Temperature range | Name | Description | Version | | | | | |
| 74LVC139D | –40 °C to +125 °C | SO16 | plastic small outline package; 16 leads; body width 3.9 mm | SOT109-1 | | | | | |
| 74LVC139DB | –40 °C to +125 °C | SSOP16 | plastic shrink small outline package; 16 leads; body width 5.3 mm | SOT338-1 | | | | | |
| 74LVC139PW | –40 °C to +125 °C | TSSOP16 | plastic thin shrink small outline package; 16 leads; body width 4.4 mm | SOT403-1 | | | | | |
| 74LVC139BQ | –40 °C to +125 °C | DHVQFN16 | plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body $2.5 \times 3.5 \times 0.85$ mm | SOT763-1 | | | | | |

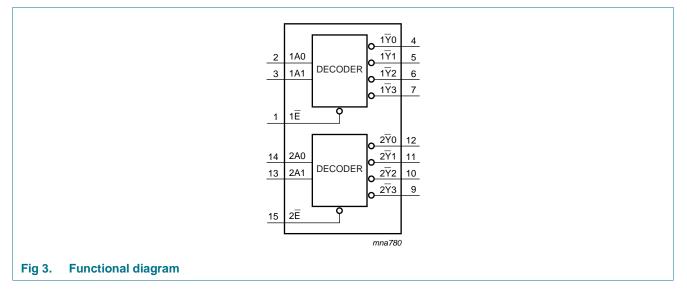
4. Functional diagram



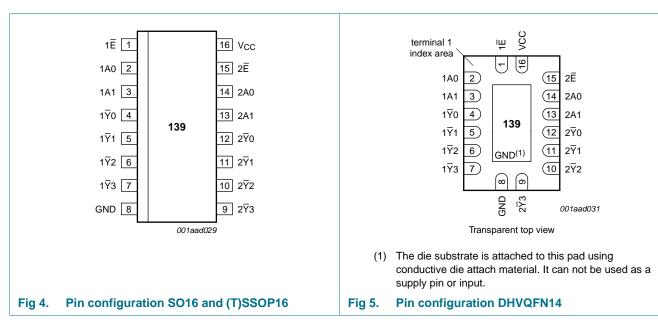
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5. Pinning information



5.1 Pinning

5.2 Pin description

| Table 2. | Pin description | | |
|------------------|-----------------|----------------------------------------------------------------------------|---------------------------------------|
| Name | Pin | Description | |
| 1E | 1 | enable input (active LOW) | |
| 2E | 15 | enable input (active LOW) | |
| 1A[0:1] | 2, 3 | address input | |
| 2A[0:1] | 14, 13 | address input | |
| 1 <u>Y[</u> 0:3] | 4, 5, 6, 7 | output | |
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| Product data | sheet | Rev. 5 — 19 October 2011 | 3 of 16 |

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| Table 2. | Pin description continued | |
|------------------|---------------------------|-------------------------|
| Name | Pin | Description |
| 2 <u>7</u> [0:3] | 12, 11, 10, 9 | output |
| GND | 8 | ground (0 V) |
| V _{CC} | 16 | positive supply voltage |

6. Functional description

Eurotion table[1]

Table 2

| Input | | | Output | Output | | | | |
|-------|-----|-----|--------|--------|-----|-----|--|--|
| nE | nA0 | nA1 | n¥0 | n¥1 | n¥2 | n¥3 | | |
| Н | Х | Х | Н | Н | Н | Н | | |
| L | L | L | L | Н | Н | Н | | |
| L | Н | L | Н | L | Н | Н | | |
| L | L | Н | Н | Н | L | Н | | |
| L | Н | Н | Н | Н | Н | L | | |

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care

7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------|-------------------------------------------------|-----------------|-----------------------|------|
| V _{CC} | supply voltage | | -0.5 | +6.5 | V |
| I _{IK} | input clamping current | V ₁ < 0 | -50 | - | mA |
| VI | input voltage | | <u>[1]</u> –0.5 | +6.5 | V |
| I _{OK} | output clamping current | $V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0 V | - | ±50 | mA |
| Vo | output voltage | | <u>[2]</u> –0.5 | V _{CC} + 0.5 | V |
| lo | output current | $V_{O} = 0 V$ to V_{CC} | - | ±50 | mA |
| I _{CC} | supply current | | - | 100 | mA |
| I _{GND} | ground current | | -100 | - | mA |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| P _{tot} | total power dissipation | $T_{amb} = -40 \text{ °C to } +125 \text{ °C}$ | <u>[3]</u> _ | 500 | mW |

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

For SO16 packages: above 70 °C derate linearly with 8 mW/K.
For SSOP16 and TSSOP16 packages: above 60 °C derate linearly with 5.5 mW/K.
For DHVQFN16 packages: above 60 °C derate linearly with 4.5 mW/K.

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Recommended operating conditions 8.

| Table 5. | Recommended operating cond | itions | | | | |
|-----------------------|--------------------------------|----------------------------|------|-----|-----------------|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| V _{CC} | supply voltage | | 1.65 | - | 3.6 | V |
| | | functional | 1.2 | - | - | V |
| VI | input voltage | | 0 | - | 5.5 | V |
| Vo | output voltage | | 0 | - | V _{CC} | V |
| T _{amb} | ambient temperature | in free air | -40 | | +125 | °C |
| $\Delta t / \Delta V$ | input transition rise and fall | V_{CC} = 1.65 V to 2.7 V | 0 | - | 20 | ns/V |
| | rate | V_{CC} = 2.7 V to 3.6 V | 0 | - | 10 | ns/V |
| | | | | | | |

Static characteristics 9.

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | -40 | °C to +8 | 85 °C | -40 °C to | o +125 °C | Unit |
|-----------------|--------------------------|--------------------------------------------------------------------|----------------------|----------------------|---------------------|----------------------|---------------------|------|
| | | | Min | Typ <mark>[1]</mark> | Мах | Min | Max | |
| VIH | HIGH-level | V _{CC} = 1.2 V | 1.08 | - | - | 1.08 | - | V |
| | input voltage | V_{CC} = 1.65 V to 1.95 V | $0.65 \times V_{CC}$ | - | - | $0.65 \times V_{CC}$ | - | V |
| | | V_{CC} = 2.3 V to 2.7 V | 1.7 | - | - | 1.7 | - | V |
| | | V_{CC} = 2.7 V to 3.6 V | 2.0 | - | - | 2.0 | - | V |
| VIL | LOW-level | V _{CC} = 1.2 V | - | - | 0.12 | - | 0.12 | V |
| | input voltage | V_{CC} = 1.65 V to 1.95 V | - | - | $0.35\times V_{CC}$ | - | $0.35\times V_{CC}$ | V |
| | | V_{CC} = 2.3 V to 2.7 V | - | - | 0.7 | - | 0.7 | V |
| | | V_{CC} = 2.7 V to 3.6 V | - | - | 0.8 | - | 0.8 | V |
| V _{OH} | HIGH-level | $V_{I} = V_{IH} \text{ or } V_{IL}$ | | | | | | |
| | output voltage | $I_{O} = -100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$ | $V_{CC}-0.2$ | - | - | $V_{CC}-0.3$ | - | V |
| | | $I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | 1.2 | - | - | 1.05 | - | V |
| | | $I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | 1.8 | - | - | 1.65 | - | V |
| | | $I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$ | 2.2 | - | - | 2.05 | - | V |
| | | $I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.4 | - | - | 2.25 | - | V |
| | | $I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.2 | - | - | 2.0 | - | V |
| V _{OL} | LOW-level | $V_{I} = V_{IH} \text{ or } V_{IL}$ | | | | | | |
| | output voltage | $I_{O} = 100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$ | - | - | 0.2 | - | 0.3 | V |
| | | I_{O} = 4 mA; V_{CC} = 1.65 V | - | - | 0.45 | - | 0.65 | V |
| | | $I_0 = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.6 | - | 0.8 | V |
| | | I_0 = 12 mA; V_{CC} = 2.7 V | - | - | 0.4 | - | 0.6 | V |
| | | $I_0 = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.55 | - | 0.8 | V |
| I _I | input leakage current | V_{CC} = 3.6 V; V_{I} = 5.5 V or GND | - | ±0.1 | ±5 | - | ±20 | μΑ |

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| Symbol | Parameter | Conditions | -40 |) °C to + | 85 °C | _40 °C t | o +125 °C | Unit |
|------------------|---------------------------------|---------------------------------------------------------------------------------------------|-----|-----------|-------|----------|-----------|------|
| | | | Min | Typ[1] | Max | Min | Max | |
| I _{CC} | supply current | $V_{CC} = 3.6 \text{ V}; V_I = V_{CC} \text{ or GND};$ $I_O = 0 \text{ A}$ | - | 0.1 | 10 | - | 40 | μA |
| ∆I _{CC} | additional supply current | per input pin ; $V_{CC} = 2.7 V \text{ to } 3.6 V;$ $V_I = V_{CC} - 0.6 V; I_O = 0 A$ | - | 5 | 500 | - | 5000 | μΑ |
| CI | input capacitance | $V_{CC} = 0 V$ to 3.6 V; $V_I = GND$ to V_{CC} | - | 5.0 | - | - | - | pF |

Table 6. Static characteristics ... continued

1 0.10

[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

10. Dynamic characteristics

Table 7. **Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 8.

| Symbol | Parameter | Conditions | | -40 | °C to +8 | 5 °C | -40 °C to | o +125 °C | Unit |
|--------------------|-------------------|---------------------------------------------------|------------|-----|----------|------|-----------|-----------|------|
| | | | - | Min | Typ[1] | Max | Min | Max | |
| t _{pd} | propagation delay | nAn to Yn; see Figure 6 | [2] | | | | | | |
| | | V _{CC} = 1.2 V | | - | 14 | - | - | - | ns |
| | | V_{CC} = 1.65 V to 1.95 V | | 0.5 | 4.7 | 10.4 | 0.5 | 11.3 | ns |
| | | V_{CC} = 2.3 V to 2.7 V | | 1.0 | 2.8 | 5.9 | 1.0 | 6.5 | ns |
| | | $V_{CC} = 2.7 V$ | | 1.0 | 3.0 | 6.3 | 1.0 | 8.0 | ns |
| | | V_{CC} = 3.0 V to 3.6 V | | 1.0 | 2.5 | 5.3 | 1.0 | 7.0 | ns |
| | | $n\overline{E}$ to $\overline{Y}n$; see Figure 7 | [2] | | | | | | |
| | | V _{CC} = 1.2 V | | - | 14 | - | - | - | ns |
| | | V_{CC} = 1.65 V to 1.95 V | | 1.5 | 4.5 | 9.8 | 1.5 | 10.7 | ns |
| | | V_{CC} = 2.3 V to 2.7 V | | 2.1 | 2.7 | 5.6 | 2.1 | 6.1 | ns |
| | | $V_{CC} = 2.7 V$ | | 1.0 | 2.8 | 5.4 | 1.0 | 7.0 | ns |
| | | V_{CC} = 3.0 V to 3.6 V | | 1.0 | 2.4 | 5.0 | 1.0 | 6.5 | ns |
| t _{sk(o)} | output skew time | V_{CC} = 3.0 V to 3.6 V | <u>[3]</u> | - | - | 1.0 | - | 1.5 | ns |
| C _{PD} | power dissipation | $V_I = GND$ to V_{CC} | <u>[4]</u> | | | | | | |
| | capacitance | V_{CC} = 1.65 V to 1.95 V | | - | 5.6 | - | - | - | pF |
| | | V_{CC} = 2.3 V to 2.7 V | | - | 11.3 | - | - | - | pF |
| | | V_{CC} = 3.0 V to 3.6 V | | - | 16.4 | - | - | - | pF |

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 P_{D} = $C_{PD} \times V_{CC}{}^{2} \times f_{i} \times N$ + $\Sigma (C_{L} \times V_{CC}{}^{2} \times f_{o})$ where:

 f_i = input frequency in MHz; f_o = output frequency in MHz

C_L = output load capacitance in pF

 V_{CC} = supply voltage in V

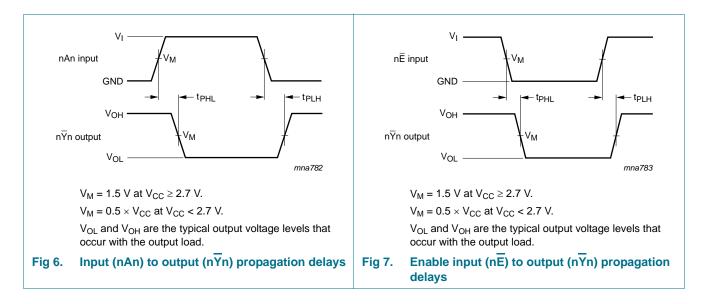
N = number of inputs switching,

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 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of outputs.

11. Waveforms



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Dual 2-to-4 line decoder/demultiplexer

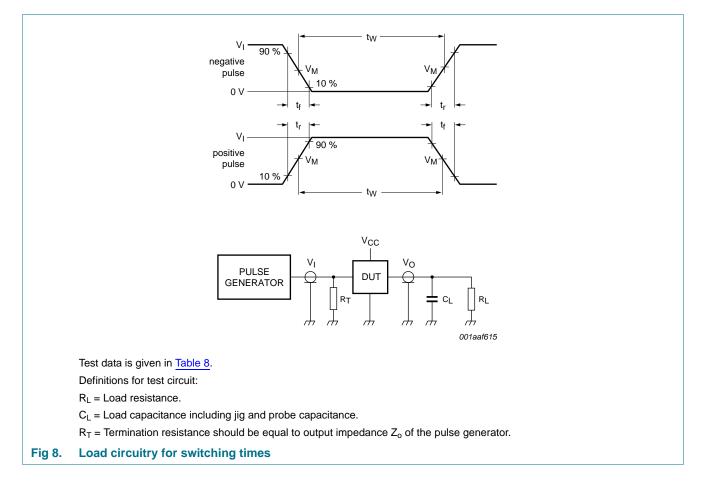


Table 8. Test data

| Supply voltage | Input | | Load | Load | | |
|------------------|-----------------|---------------------------------|-------|-------|--|--|
| | V _I | t _r , t _f | CL | RL | | |
| 1.2 V | V _{CC} | \leq 2 ns | 30 pF | 1 kΩ | | |
| 1.65 V to 1.95 V | V _{CC} | \leq 2 ns | 30 pF | 1 kΩ | | |
| 2.3 V to 2.7 V | V _{CC} | \leq 2 ns | 30 pF | 500 Ω | | |
| 2.7 V | 2.7 V | \leq 2.5 ns | 50 pF | 500 Ω | | |
| 3.0 V to 3.6 V | 2.7 V | \leq 2.5 ns | 50 pF | 500 Ω | | |

Dual 2-to-4 line decoder/demultiplexer

12. Package outline

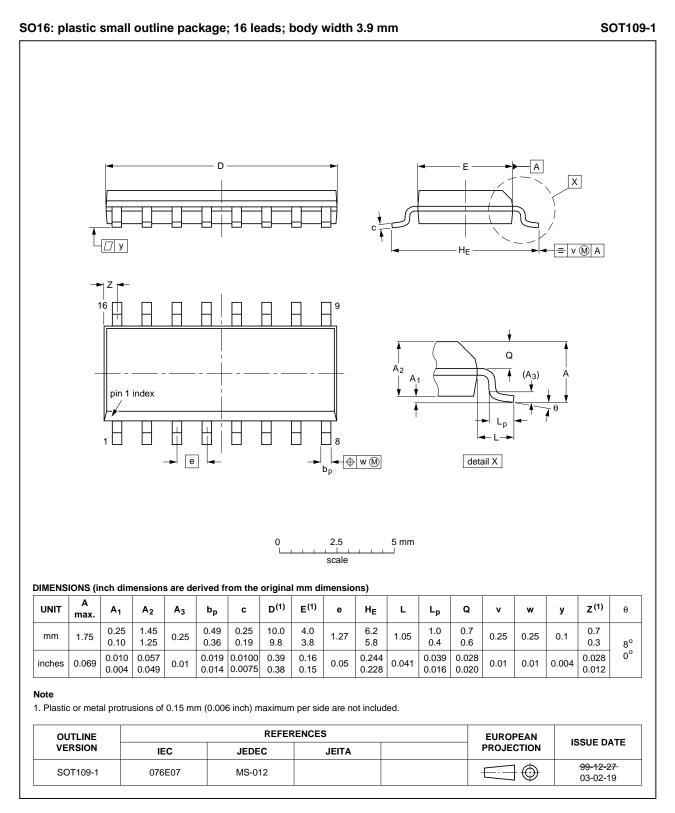


Fig 9. Package outline SOT109-1 (SO16)

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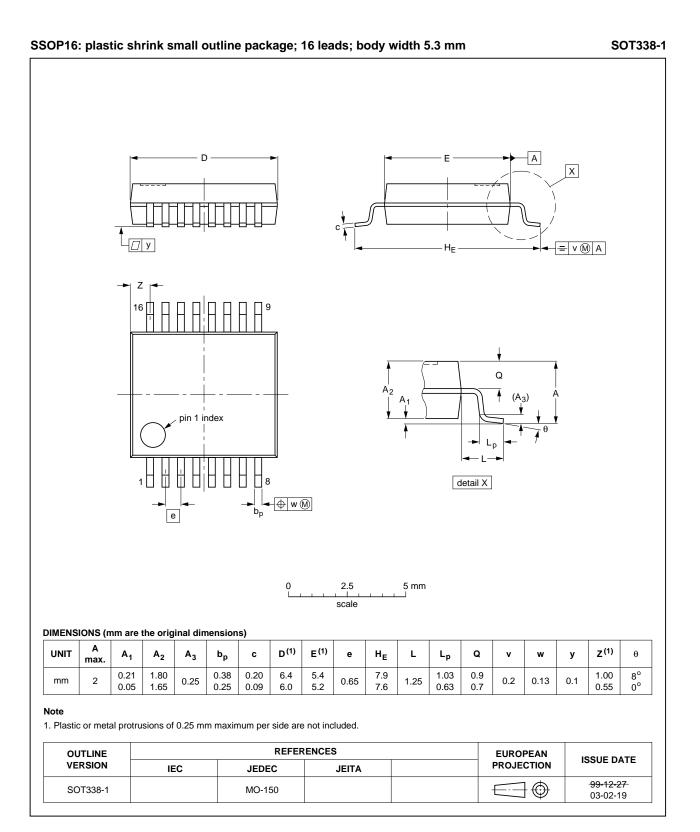
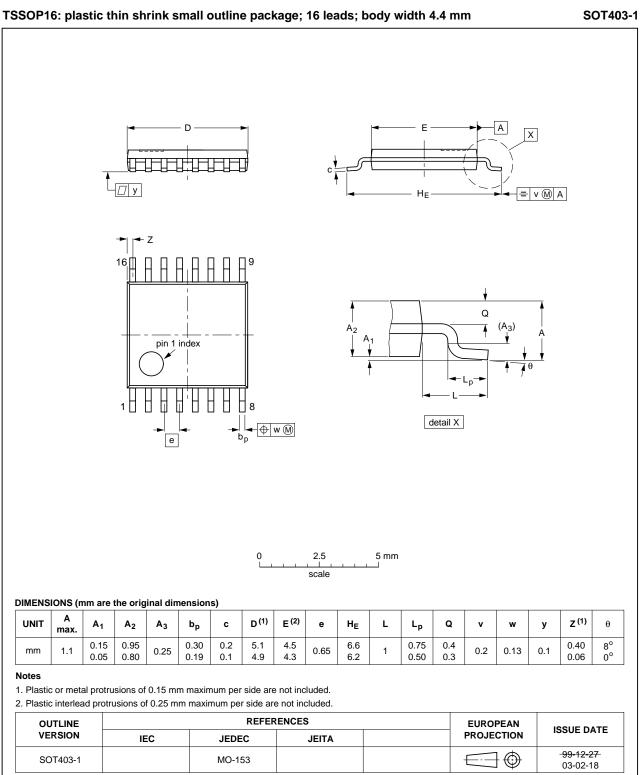


Fig 10. Package outline SOT338-1 (SSOP16)

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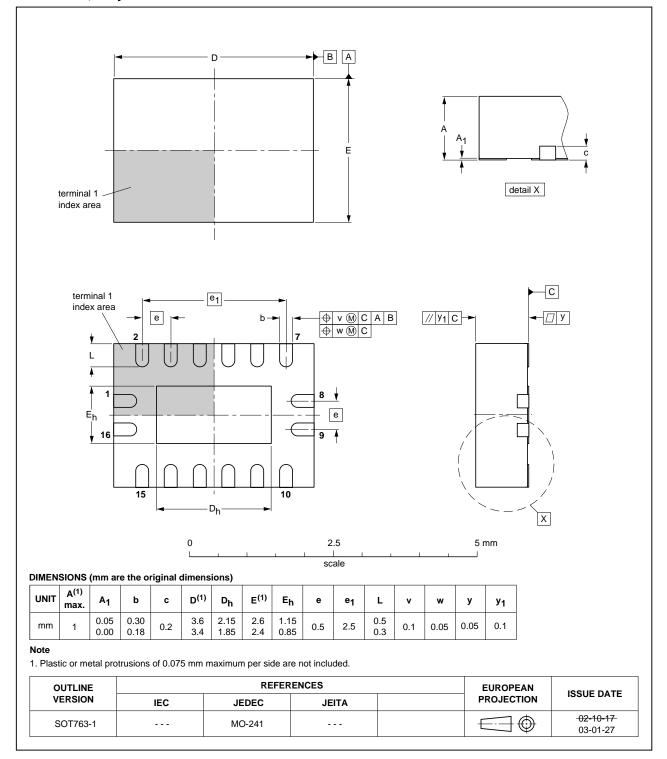


| OUTLINE | | REFER | ENCES | EUROPEAN | ISSUE DATE | |
|----------|-----|--------|-------|---------------------|-----------------------------------|--|
| VERSION | IEC | JEDEC | JEITA | PROJECTION | ISSUE DATE | |
| SOT403-1 | | MO-153 | | $\bigcirc \bigcirc$ | - 99-12-27 03-02-18 | |
| | | | | | | |

Fig 11. Package outline SOT403-1 (TSSOP16)

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DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

Fig 12. Package outline SOT763-1 (DHVQFN16)

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Dual 2-to-4 line decoder/demultiplexer

13. Abbreviations

| Table 9. | Abbreviations |
|----------|-----------------------------|
| Acronym | Description |
| CDM | Charged Device Model |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| HBM | Human Body Model |
| MM | Machine Model |
| TTL | Transistor-Transistor Logic |

14. Revision history

| Table 10. Revision hi | story | | | |
|-----------------------|------------------|-----------------------------------------------------------------|---------------|--------------|
| Document ID | Release date | Data sheet status | Change notice | Supersedes |
| 74LVC139 v.5 | 20111019 | Product data sheet | - | 74LVC139 v.4 |
| Modifications: | of NXP Semicondu | data sheet has been rede ictors. een adapted to the new c | • | |
| | - | able 6, Table 7 and Table | | - |
| 74LVC139 v.4 | 040315 | Product specification | - | 74LVC139 v.3 |
| 74LVC139 v.3 | 030519 | Product specification | - | 74LVC139 v.2 |
| 74LVC139 v.2 | 980428 | Product specification | - | 74LVC139 v.1 |
| 74LVC139 v.1 | - | - | - | - |

15. Legal information

15.1 Data sheet status

| Document status[1][2] | Product status ^[3] | Definition |
|--------------------------------|-------------------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
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[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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